

AM83135-015

PRELIMINARY DATA

RF & MICROWAVE TRANSISTORS S-BAND RADAR APPLICATIONS

- REFRACTORY/GOLD METALLIZATION
- EMITTER SITE BALLASTED
- LOW THERMAL RESISTANCE
- INPUT/OUTPUT MATCHING
- OVERLAY GEOMETRY
- METAL/CERAMIC HERMETIC PACKAGE
- Pout = 15 W MIN. WITH 5.2 dB GAIN

DESCRIPTION

The AM83135-015 device is a high power silicon bipolar NPN transistor specifically designed for S-Band radar pulsed output and driver applications.

This device is characterized at 100μ sec pulse width and 10% duty cycle, but is capable of operation over a range of pulse widths, duty cycles, and temperatures, and can withstand a 3:1 output VSWR with a + 1 dB input overdrive. Low RF thermal resistance, refractory/gold metallization, and computerized automatic wire bonding techniques ensure high reliability and product consistency (including phase characteristics).

The AM83135-015 is supplied in the IMPAC[™] Hermetic Metal/Ceramic package with internal Input/Output impedance matching circuitry, and is intended for military and other high reliability applications.



1. Collector

2. Base

3. Emitter

4. Base

ADJULUIE MAAIMUWI KATINGJ (Icase - 20 C	ABSOLUTE MAXIMUM RATINGS ($T_{case} = 25^{\circ}C$
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Symbol	Parameter	Value	Unit	
PDISS	Power Dissipation* $(T_C \le 50^{\circ}C)$	71	W	
lc	Device Current*	3.0	А	
Vcc	Collector-Supply Voltage*	46	V	
TJ	Junction Temperature (Pulsed RF Operation)	250	°C	
T _{STG}	Storage Temperature	– 65 to +200	°C	

THERMAL DATA

R _{TH(j-c)}	Junction-Case Thermal Resistance*	2.8	°C/W				
*Applies only to rated PE amplifier operation							

*Applies only to rated RF amplifier operation

ELECTRICAL SPECIFICATIONS ($T_{case} = 25^{\circ}C$)

STATIC

Symbol	Test Conditions	Value			Unit		
	Test conditions		Min.	Тур.	Max.	Unit	
BV _{CBO}	$I_C = 10 \text{ mA}$	$I_E = 0 mA$		55	—	—	V
BV _{EBO}	$I_E = 2 \text{ mA}$	$I_{C} = 0 \text{ mA}$		3.5	_		V
BV _{CER}	$I_C = 10 \text{ mA}$	$R_{BE} = 10 \ \Omega$		55			V
I _{CES}	$V_{BE} = 0 V$	$V_{CE} = 40 V$				8	mA
hFE	$V_{CE} = 5 V$	$I_C = 1 A$		30	_	300	

DYNAMIC

Symbol	Symbol Test Conditions				Value		Unit
Symbol		Test Conditions			Тур.	Max.	
Pout	f = 3.1 - 3.5 GHz	$P_{IN}=4.5\ W$	$V_{CC} = 40 \ V$	15			W
η _c	f = 3.1 - 3.5 GHz	$P_{OUT} = 15 W$	$V_{CC} = 40 V$	30	_		%
Pg	f = 3.1 - 3.5 GHz	$P_{OUT} = 15 W$	$V_{CC} = 40 V$	5.2			dB

Note: Pulse Width = 100μ S Duty Cycle = 10%



PACKAGE MECHANICAL DATA



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